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- new method to suppress harmonics using $\langle F_{128} \rangle \langle F_{255} \rangle / 4$ bias line combined by defected ground structure in power amplifiers. *Jeong, Y.-C.*, + , *MWCL Dec 03* 538-540

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- Low noise 5 GHz differential VCO using InGaP/GaAs HBT technology. *Yunseong Eo*, + , *MWCL Jul 03* 259-261
- Noise anal. of photoreceiver using, P-I-N and GaAs HBT distributed amp. combination. *Xizhen Tian*, + , *MWCL Jun 03* 208-210
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- AlGaAs/InGaAs/GaAs PHEMT MMIC power amp., automotive radar. *Hong-Yeh Chang*, + , *MWCL Apr 03* 143-145
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- spiral inductors, Si, proton implant., large Q-factor improv. *Chan, K.T.*, + , *MWCL Nov 03* 460-462

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- Dual-gate FET subharmonic injection-locked self-oscillating act. integrated antenna for RF transm. *Yan Chen*, + , *MWCL Jun 03* 199-201
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